

Silicon Schottky Rectifier in bare die form

Applications

- Switching Power Supply
- Converters
- Free Wheeling Diodes

Electrical Characteristics

Version 1.0 06/04/18

Features

- Ultra Low Reverse Current
- Soft recovery low & high temperature
- Low forward Voltage drop

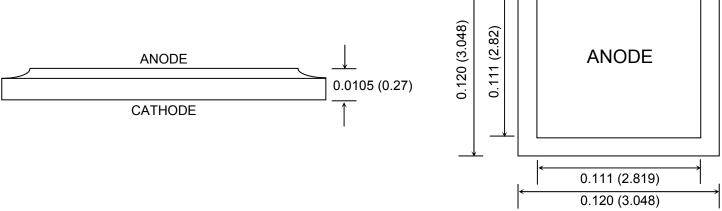
Symbol	Parameter	neter Conditions		Max	Unit
V _R	Reverse Voltage	-	-	30	V
		V _R = 30V,T _J = 25°C	-	2.00	mA
I _R	Reverse Current	¹ V _R = 30V,T _J = 125°C	-	100.0	mA
V _F	Forward Voltage	I _F = 15A @ 25°C	-	0.49	V
TJ	Junction Temperature	-	-	150	°C

Note 1: Not production tested at wafer level, tested in package

Mechanical Data

Die Attach Method	Front Metal Composition			Back Metal Composition		
Wire Bondable Top Solderable Back	-	AI (1% Si) 25kÅ	-	Ti	Ni	Ag 30kÅ

Die Drawing - Dimensions in Inches(mm)



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